

## PATENT ASSIGNMENT COVER SHEET

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| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT                                       |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT   |
| <b>CONVEYING PARTY DATA</b>   |  |
| <b>Name</b>   | <b>Execution Date</b>                                |
| HIROYUKI SUZUKI   | 07/28/2014   |
| <b>RECEIVING PARTY DATA</b>   |  |
| <b>Name:</b>  | YAZAKI CORPORATION                                   |
| <b>Street Address:</b>  | 4-28, MITA 1-CHOME                                   |
| <b>City:</b>  | MINATO-KU, TOKYO                                     |
| <b>State/Country:</b>   | JAPAN  |
| <b>Postal Code:</b>   | 108-8333   |
| <b>PROPERTY NUMBERS Total: 1</b>  |  |
| <b>Property Type</b>  | <b>Number</b>  |
| Application Number:   | 14464962   |
| <b>CORRESPONDENCE DATA</b>  |  |
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| <b>Correspondent Name:</b>  | BANNER & WITCOFF, LTD.                               |
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| <b>Address Line 4:</b>  | WASHINGTON, D.C. 20005                               |
| <b>ATTORNEY DOCKET NUMBER:</b>  | 007936.00042   |
| <b>NAME OF SUBMITTER:</b>   | CHUNHSI ANDY MU                                      |
| <b>SIGNATURE:</b>   | /Chunhsi Andy Mu/                                    |
| <b>DATE SIGNED:</b>   | 08/26/2014   |
| <b>Total Attachments: 1</b>   |  |
| source=Assignment#page1.tif   |  |

**ASSIGNMENT**

(1-8) **Insert Name(s) of Inventor(s)**

(1) Hiroyuki SUZUKI (5) \_\_\_\_\_  
 (2) \_\_\_\_\_ (6) \_\_\_\_\_  
 (3) \_\_\_\_\_ (7) \_\_\_\_\_  
 (4) \_\_\_\_\_ (8) \_\_\_\_\_

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) **Insert Name of Assignee** (9) Yazaki Corporation  
 (10) **Insert Address of Assignee** (10) 4-28, MITA 1-CHOME, MINATO-KU, TOKYO, 108-8333, JAPAN

(hereinafter designated as the Assignee) the entire right, title and interest for the United States of America as defined in 35 U.S.C. §100, in the invention, and in all applications for patent including any and all provisional, non-provisional, divisional, continuation, substitute, and reissue application(s), and all Letters Patent, extensions, reissues and reexamination certificates that may be granted on the invention known as

(11) **Insert Identification of Invention such as Title, Case Number, or Foreign Application Number**

(11) WIRE PROTECTION STRUCTURE  
 \_\_\_\_\_  
 \_\_\_\_\_  
 (Attorney Docket No. \_\_\_\_\_ )  
 for which the undersigned has (have) executed an application for patent in the United States of America

(12) **Insert Date of Signing of Application**

(12) on July 28, 2014

(13) **Alternative Identification for filed applications**

(13) U.S. application Serial Number \_\_\_\_\_  
 filed \_\_\_\_\_

1) The undersigned agree(s) to execute all papers necessary in connection with any application and any continuing, divisional or reissue applications for the invention, and any patent(s) issuing thereon, and also to execute separate assignments in connection with such applications and patents as the Assignees may deem necessary.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning any application or continuation or division thereof, or any patent or reissue application based thereon, for the invention, and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain, maintain or confirm by reissue or reexamination a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application(s) to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreements in conflict herewith.

6) The undersigned hereby grant(s) the firm of **Banner & Witcoff, LTD** the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

|      |                      |                  |   |        |
|------|----------------------|------------------|---|--------|
| Date | <u>July 28, 2014</u> | Name of Inventor | <u>Hiroyuki Suzuki</u><br>Hiroyuki SUZUKI | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |
| Date | _____                | Name of Inventor | _____                                     | (SEAL) |

**PATENT** (SEAL)